PA343

High Voltage Power Operational Amplifier

FEATURES
♦ RoHS COMPLIANT
♦ SURFACE MOUNT PACKAGE
♦ MONOLITHIC MOS TECHNOLOGY
♦ LOW COST
♦ HIGH VOLTAGE OPERATION – 350V
♦ LOW QUIESCENT CURRENT TYP. – 2.2mA
♦ NO SECOND BREAKDOWN
♦ HIGH OUTPUT CURRENT – 120 mA PEAK

APPLICATIONS
♦ TELEPHONE RING GENERATOR
♦ PIEZO ELECTRIC POSITIONING
♦ ELECTROSTATIC TRANSDUCER & DEFLECTION
♦ DEFORMABLE MIRROR FOCUSING

DESCRIPTION
The PA343 is a dual high voltage monolithic MOSFET operational amplifier achieving performance features previously found only in hybrid designs while increasing reliability. This approach provides a cost-effective solution to applications where multiple amplifiers are required. Inputs are protected from excessive common mode and differential mode voltages. The safe operating area (SOA) has no secondary breakdown limitations and can be observed with all type loads by choosing an appropriate current limiting resistor. External compensation provides the user flexibility in choosing optimum gain and bandwidth for the application.

The PA343DF is packaged in a 24 pin PSOP (JEDEC MO-166) package. The heatslug of the PA343DF package is isolated in excess of full supply voltage.

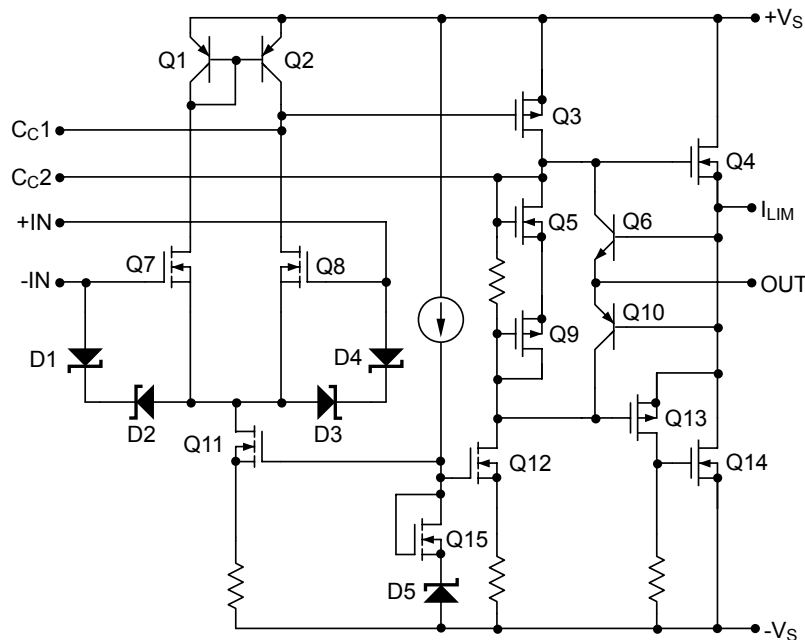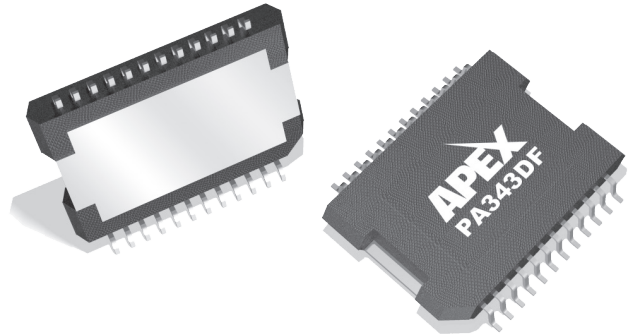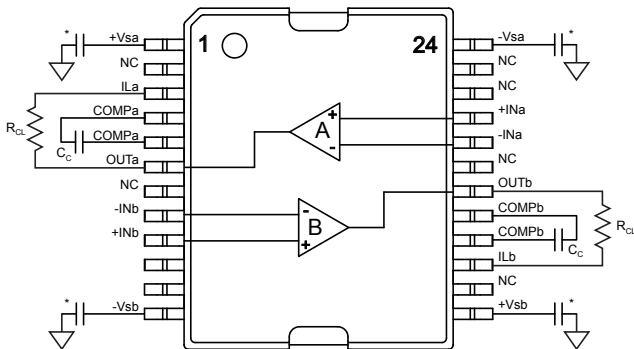**FIGURE 1: Equivalent Schematic (one of 2 Amplifiers)**

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FIGURE 2. External Connections.

For C_C values, see graph on page 4.
Note: C_C must be rated for full supply voltage.
* Supply bypassing required. See general Operating Considerations.

24-pin PSOP
PACKAGE STYLE DF

TYPICAL APPLICATION

A single PA343 amplifier operates as a bridge driver for a piezo transducer providing a low cost 660 volt total drive capability. The R_N C_N network serves to raise the apparent gain of A2 at high frequencies. If R_N is set equal to R the amplifiers can be compensated identically and will have matching bandwidths. See application note 20 for more details.
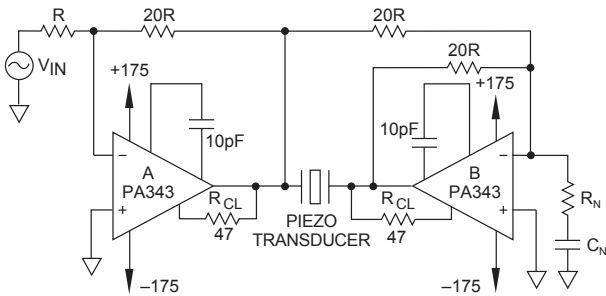

FIGURE 3. Low Cost 660v $_{p-p}$ Piezo Drive

1. CHARACTERISTICS AND SPECIFICATIONS

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Units
SUPPLY VOLTAGE, $+V_S$ to $-V_S$			350	V
OUTPUT CURRENT, continuous within SOA			60	mA
OUTPUT CURRENT, peak			120	mA
POWER DISSIPATION, continuous @ $T_C = 25°C$ (Note 7)			12	W
INPUT VOLTAGE, differential		-16	+16	V
INPUT VOLTAGE, common mode		$-V_S$	$+V_S$	V
TEMPERATURE, pin solder - 10 sec			220	°C
TEMPERATURE, junction (Note 2)			150	°C
TEMPERATURE, storage		-65	150	°C
TEMPERATURE RANGE, powered (case)		-40	125	°C

SPECIFICATIONS (PER AMPLIFIER)

Parameter	Test Conditions (Note 1)	Min	Typ	Max	Units
INPUT					
OFFSET VOLTAGE, initial			12	40	mV
OFFSET VOLTAGE, vs. temperature (Note 3)	25°C to 85°C		17	250	µV/°C
OFFSET VOLTAGE, vs. temperature (Note 3)	-25°C to 25°C		18	500	µV/°C
OFFSET VOLTAGE, vs. supply			4.5		µV/V
OFFSET VOLTAGE, vs. time			80		µV/kh
BIAS CURRENT, initial			50	200	pA
BIAS CURRENT, vs. supply			2		pA/V
OFFSET CURRENT, initial			50	200	pA
INPUT IMPEDANCE, DC			10^{11}		Ω
INPUT CAPACITANCE			3		pF
COMMON MODE, voltage range		$+V_S - 12$			V
COMMON MODE, voltage range		$-V_S + 12$			V
COMMON MODE REJECTION, DC	$V_{CM} = ±90VDC$	84	115		dB
NOISE, broad band	10kHz BW, $R_S = 1KΩ$		337		µV RMS
GAIN					
OPEN LOOP at 15Hz	$R_L = 5KΩ$	90	103		dB
GAIN BANDWIDTH PRODUCT	@1MHz		10		MHz
POWER BANDWIDTH	280V p-p		35		kHz

Parameter	Test Conditions (Note 1)	Min	Typ	Max	Units
OUTPUT					
VOLTAGE SWING	I_O = 40mA	$\pm V_S$ - 12	$\pm V_S$ - 10		V
CURRENT, peak (Note 3)		120			mA
CURRENT, continuous		60			mA
SETTLING TIME to 0.1%	10V step, A_V = -10		2		µs
SLEW RATE	C_C = 4.7pF		32		V/µS
RESISTANCE, 10mA (Note 4)	R_{CL} = 0Ω		91		Ω
RESISTANCE, 40mA (Note 4)	R_{CL} = 0Ω		65		Ω
POWER SUPPLY					
VOLTAGE		±10	±150	±175	V
CURRENT, quiescent (Note 7)			2.2	2.5	mA
THERMAL					
RESISTANCE, junction to case					
AC, single amplifier	F > 60Hz		6	7	°C/W
DC, single amplifier	F < 60Hz		9	11	°C/W
AC, both amplifier (Note 5)			3.3	4.0	°C/W
DC, both amplifier (Note 5)			5.0	6.0	°C/W
RESISTANCE, junction to air (Note 6)	Full temperature range		25		°C/W
TEMPERATURE RANGE, case	Meets full range specifications	-25		+85	°C

NOTES:

1. Unless otherwise noted T_C = 25°C, C_C = 6.8pF. DC input specifications are ± value given. Power supply voltage is typical rating.
2. Long term operation at the maximum junction temperature will result in reduced product life. Derate internal power dissipation to achieve high MTTF. For guidance, refer to heatsink data sheet.
3. Guaranteed but not tested.
4. The selected value of R_{CL} must be added to the values given for total output resistance.
5. Rating applies when power dissipation is equal in the two amplifiers.
6. Rating applies with solder connection of heatslug to a minimum 1in^2 foil area of the printed circuit board.
7. Specifications are for individual amplifiers in this device, unless otherwise noted.

CAUTION   The PA343 is constructed from MOSFET transistors. ESD handling procedures must be observed.

2. TYPICAL PERFORMANCE GRAPHS

POWER DERATING

V_{BE} for I_{LIMIT}

GAIN AND COMPENSATION

SMALL SIGNAL RESPONSE

PHASE RESPONSE

POWER RESPONSE

HARMONIC DISTORTION

SLEW RATE

QUIESCENT CURRENT

COMMON MODE REJECTION

POWER SUPPLY REJECTION

OUTPUT VOLTAGE SWING
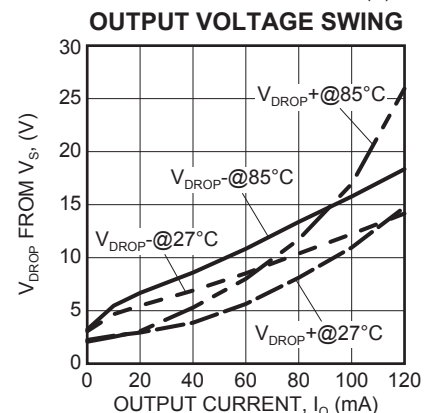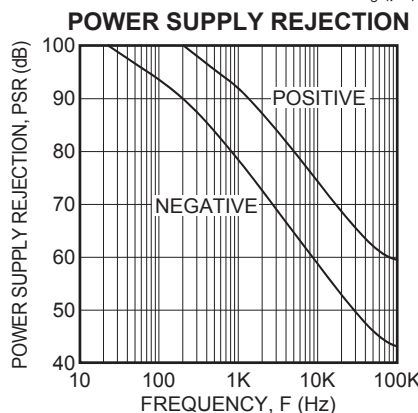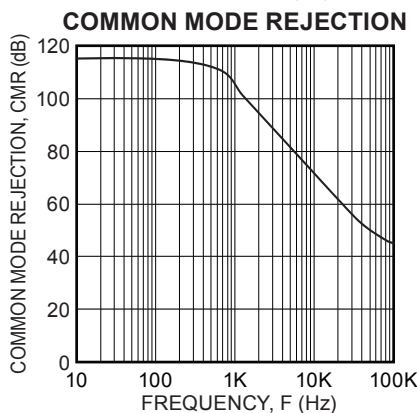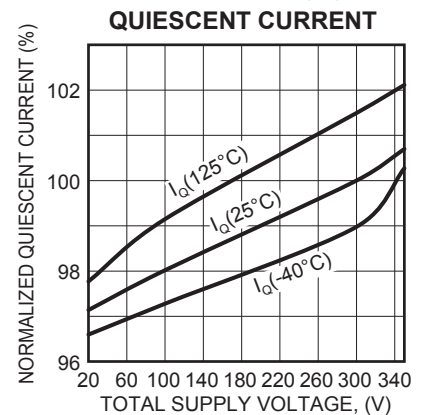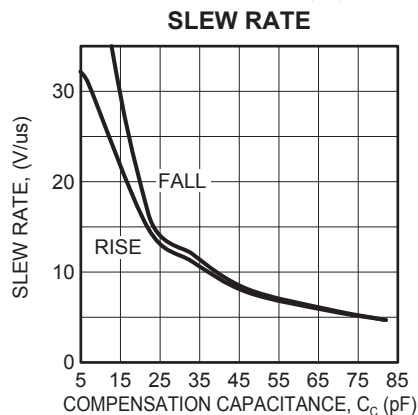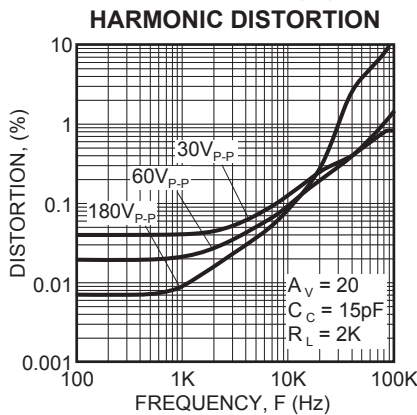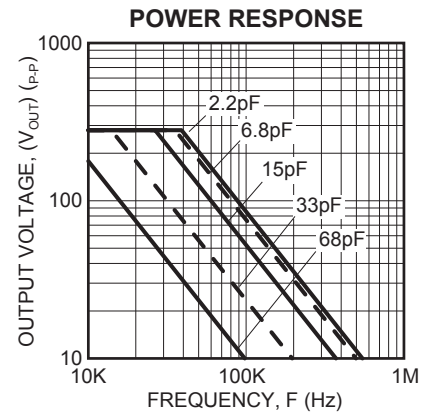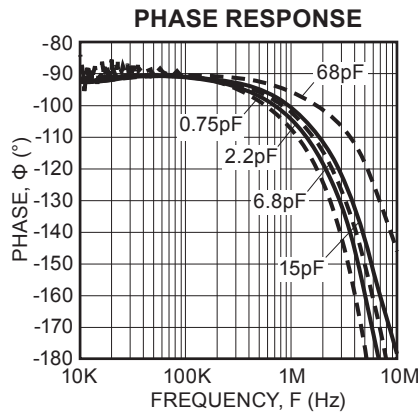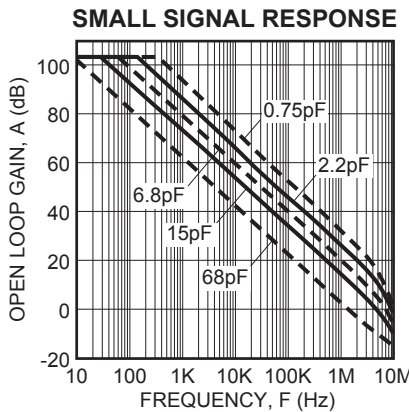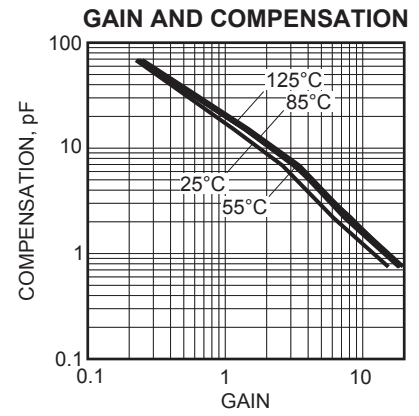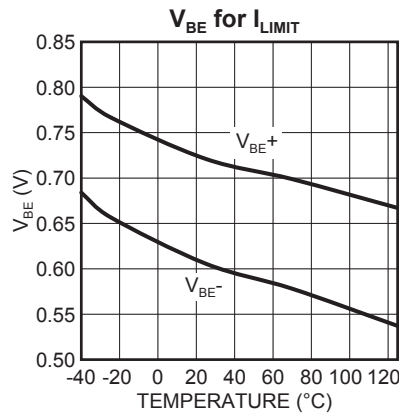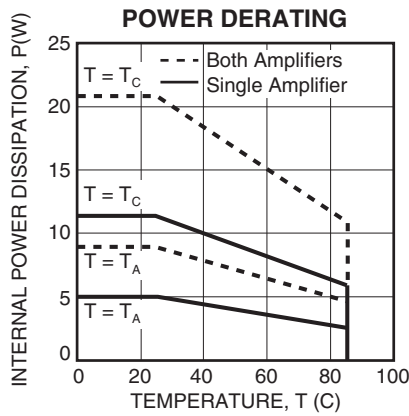
3. APPLICATION INFORMATION

Please read Application Note 1 "General Operating Considerations" which covers stability, power supplies, heat sinking, mounting, current limit, SOA interpretation, and specification interpretation. Visit www.apexanalog.com for design tools that help automate tasks such as calculations for stability, internal power dissipation, current limit, heat sink selection, Apex Microtechnology's complete Application Notes library, Technical Seminar Workbook and Evaluation Kits.

3.1 PHASE COMPENSATION

Open loop gain and phase shift both increase with increasing temperature. The PHASE COMPENSATION typical graph shows closed loop gain and phase compensation capacitor value relationships for four case temperatures. The curves are based on achieving a phase margin of 50°. Calculate the highest case temperature for the application (maximum ambient temperature and highest internal power dissipation) before choosing the compensation. Keep in mind that when working with small values of compensation, parasitics may play a large role in performance of the finished circuit. The compensation capacitor must be rated for at least the total voltage applied to the amplifier and should be a temperature stable type such as NPO or COG.

3.2 OTHER STABILITY CONCERNS

There are two important concepts about closed loop gain when choosing compensation. They stem from the fact that while "gain" is the most commonly used term, β (the feedback factor) is really what counts when designing for stability.

1. Gain must be calculated as a non-inverting circuit (equal input and feedback resistors can provide a signal gain of -1, but for calculating offset errors, noise, and stability, this is a gain of 2).
2. Including a feedback capacitor changes the feedback factor or gain of the circuit. Consider Rin=4.7k, Rf=47k for a gain of 11. Compensation of 4.7 to 6.8pF would be reasonable. Adding 33pF parallel to the 47k rolls off the circuit at 103kHz, and at 2MHz has reduced gain from 11 to roughly 1.5 and the circuit is likely to oscillate.

As a general rule the DC summing junction impedance (parallel combination of the feedback resistor and all input resistors) should be limited to 5k ohms or less. The amplifier input capacitance of about 6pF, plus capacitance of connecting traces or wires and (if used) a socket will cause undesirable circuit performance and even oscillation if these resistances are too high. In circuits requiring high resistances, measure or estimate the total sum point capacitance, multiply by Rin/Rf, and parallel Rf with this value. Capacitors included for this purpose are usually in the single digit pF range. This technique results in equal feedback factor calculations for AC and DC cases. It does not produce a roll off, but merely keeps β constant over a wide frequency range. Paragraph 6 of Application Note 19 details suitable stability tests for the finished circuit.

3.3 CURRENT LIMIT

For proper operation, the current limiting resistor, R_{CL}, must be connected as shown in Figure 3, "External Connections". The current limit can be predicted as follows:

$$I_{LIMIT} = \frac{V_{BE}}{R_{CL}}$$

The "V_{BE} for I_{LIMIT}" performance graph is used to find V_{BE}. On this graph, the $V_{BE}+$ and $V_{BE}-$ curves show the voltages across the current limiting resistor at which current limiting is turned on. The $V_{BE}+$ curve shows these turn-on voltages when the amplifier is sourcing current, and the $V_{BE}-$ curve shows these voltages when the amplifier is sinking current.

The current limit can be thought of as a ceiling or limit for safe operation. For continuous operation it is any value between the desired load current and 60 mA (as long as the curves on the SOA graph are not exceeded, please

refer to section 3.4 for information on the SOA graph). As an example, suppose the desired load current for the application is 20 mA. In this case we may set a current limit of 30 mA. Starting with the smaller V_{BE}^- of 0.6 we have:

$$R_{CL} = \frac{0.6}{1.03} = 20\Omega$$

For the larger V_{BE}^+ this R_{CL} resistor will allow for a maximum current of:

$$I_{LIMIT} = \frac{0.7}{20} = 35mA$$

This value is still acceptable because it is less than 60 mA. For the case of continuous load currents, check that the current limit does not exceed 60 mA.

The V_{BE} values used above are approximate and can vary with process. To allow for this possibility the user can reduce the $V_{BE} = 0.6$ value by 20%. This results in a R_{CL} value of 16 Ω. Using this same R_{CL} value and allowing for a 20% increase in the other V_{BE} , the current limit maximum is 52 mA.

The absolute minimum value of the current limiting resistor is bounded by the largest current and the largest V_{BE} in the application. The largest V_{BE} is determined by the coldest temperature in the application. In general the largest V_{BE} is $V_{BE}+ = 0.78$, which occurs at T = − 40°C. The largest allowed current occurs in pulsed applications where, from the SOA graph, we can see current pulses of 120 mA. This gives us an absolute minimum R_{CL} value of 0.78/0.12 = 6.5Ω.

3.4   SAFE OPERATING AREA

The MOSFET output stage of the PA343 is not limited by second breakdown considerations as in bipolar output stages. However there are still three distinct limitations:
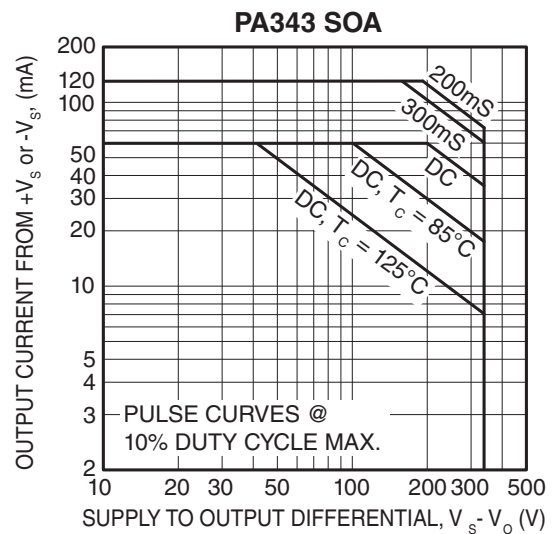
1. Voltage withstand capability of the transistors.
2. Current handling capability of the die metalization.
3. Temperature of the output MOSFETS.

These limitations can be seen in the SOA (see Safe Operating Area graphs). Note that each pulse capability line shows a constant power level (unlike second breakdown limitations where power varies with voltage stress). These lines are shown for a case temperature of 25°C and correspond to thermal resistances of 5.2°C/W for the PA343DF. Pulse stress levels for other case temperatures can be calculated in the same manner as DC power levels at different temperatures. The output stage is protected against transient flyback by the parasitic diodes of the output stage MOSFET structure. However, for protection against sustained high energy flyback external fast-recovery diodes must be used.

FIGURE 4. Safe Operating Area

PA343 SOA

3.5   HEATSINKING

The PA343DF package has a large exposed integrated copper heatslug to which the monolithic amplifier is directly attached. The solder connection of the heatslug to a minimum of 1 square inch foil area on the printed circuit board will result in thermal performance of 25°C/W junction to air rating of the PA343DF. Solder connection to an area of 1 to 2 square inches is recommended. This may be adequate heatsinking but the large number of variables involved suggest temperature measurements be made on the top of the package. Do not allow the temperature to exceed 85°C.
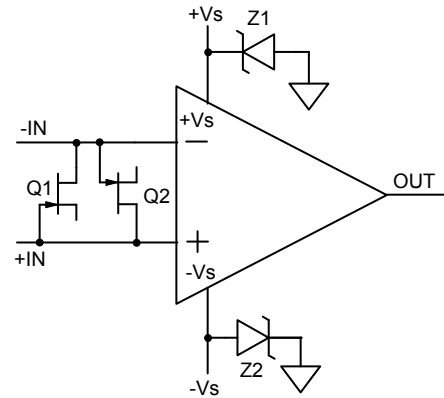
3.6 OVERVOLTAGE PROTECTION

Although the PA343 can withstand differential input voltages up to 16V, in some applications additional external protection may be needed. Differential inputs exceeding 16V will be clipped by the protection circuitry. However, if more than a few milliamps of current is available from the overload source, the protection circuitry could be destroyed. For differential sources above 16V, adding series resistance limiting input current to 1mA will prevent damage. Alternatively, 1N4148 signal diodes connected anti-parallel across the input pins is usually sufficient. In more demanding applications where bias current is important, diode connected JFETs such as 2N4416 will be required. See Q1 and Q2 in Figure 5. In either case the differential input voltage will be clamped to 0.7V. This is sufficient overdrive to produce the maximum power bandwidth.

FIGURE 5. Overvoltage Protection

In the case of inverting circuits where the +IN pin is grounded, the diodes mentioned above will also afford protection from excessive common mode voltage. In the case of non-inverting circuits, clamp diodes from each input to each supply will provide protection. Note that these diodes will have substantial reverse bias voltage under normal operation and diode leakage will produce errors.

Some applications will also need over-voltage protection devices connected to the power supply rails. Unidirectional zener diode transient suppressors are recommended. The zeners clamp transients to voltages within the power supply rating and also clamp power supply reversals to ground. Whether the zeners are used or not the system power supply should be evaluated for transient performance including power-on overshoot and power-off polarity reversals as well as line regulation. See Z1 and Z2 in Figure 5.

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